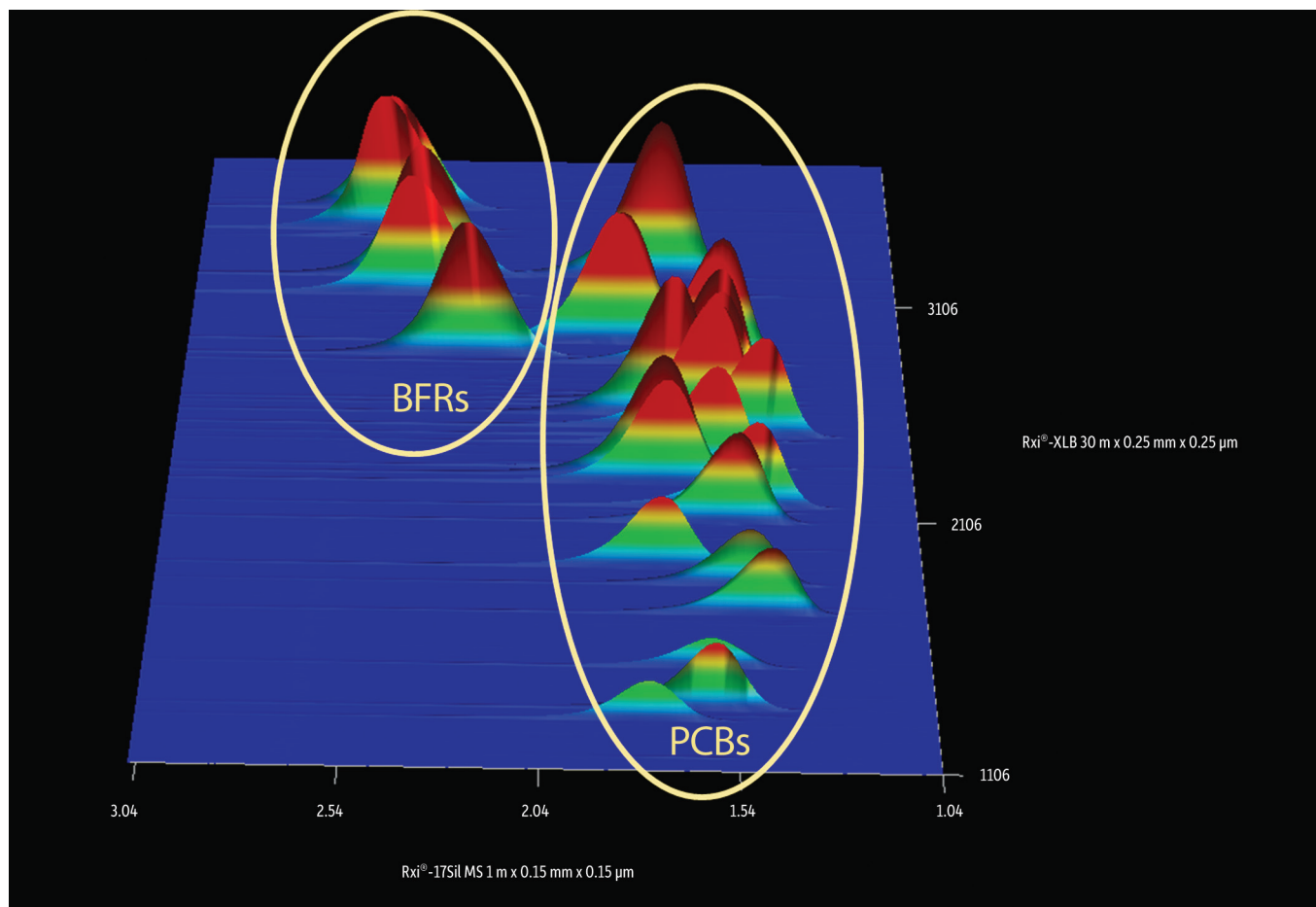


PCBs and BFRs on Rxi®-XLB and Rxi®-17Sil MS (GCxGC)



GC\_EV1237

**Column** Rxi®-XLB 30 m, 0.25 mm ID, 0.25 μm (cat.# 13723)  
 Rxi®-17Sil MS 1 m, 0.15 mm ID, 0.15 μm (cat.# 43820)  
 with IP Deactivated Guard Column 0.2 m, 0.15 mm ID

**Sample** PBDE Mix (cat.# 33098)  
 PCB Congener Mix, Method 8082A (cat.# 32416)

**Diluent:** isoootane  
**Conc.:** 250 pg/μL

**Injection**  
 Inj. Vol.: 1.0 μL splitless (hold 1.0 min.)  
 Liner: Premium 4mm Single Taper Gooseneck w/Wool (cat.# 23303.5)  
 Inj. Temp.: 250 °C  
 Purge Flow: 20 mL/min.

**Oven**  
 Oven Temp: Rxi®-XLB: 80 °C (hold 1 min.) to 120 °C at 10 °C/min. to 300 °C at 3 °C/min.  
 Rxi®-17Sil MS: 85 °C (hold 1 min.) to 125 °C at 10 °C/min. to 305 °C at 3 °C/min.

**Carrier Gas** He, corrected constant flow (2.0 mL/min.)

**Modulation**  
 Modulator Temp. Offset: 20 °C  
 Second Dimension Separation Time: 3.5 sec.  
 Hot Pulse Time: 1.25 sec.  
 Cool Time between Stages: 0.50 sec.

**Detector** μ-ECD @ 325 °C  
 Data Rate: 50 Hz

**Instrument** Agilent/HP6890 GC

**Notes** The Rxi®-17Sil MS column (cat.# 43820) is a 10 m column. A 1 m section was used as a second dimension column. Guard column was connected using a Siltek® treated universal Press-Tight® connector (cat.# 20480).